

Features

- Uses MHCHXM advanced PerfectMOS technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Excellent Low Ciss
- Qualified according to JEDEC criteria

Applications

- Switching application
- Li-battery protection
- DC-DC

Benefits

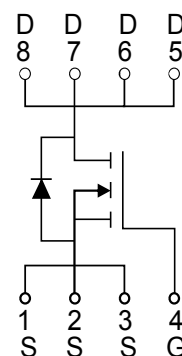
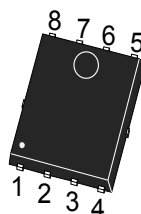
- High robustness and reliability
- Increases maximum current capability
- Low power loss, high power density
- Easy paralleling

Product Summary

V_{DS}	40V
$R_{DS(on)}@10V$ typ	0.86m Ω
I_D	260A



PDFN5060-8L



Absolute Maximum Ratings ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	260	A
Drain Current-Continuous($T_C=100^{\circ}\text{C}$)	$I_D(100^{\circ}\text{C})$	210	A
Pulsed Drain Current	I_{DM}	380	A
Maximum Power Dissipation	P_D	200	W
Derating factor		1.9	W/ $^{\circ}\text{C}$
Single pulse avalanche energy (Note 5)	E_{AS}	368	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^{\circ}\text{C}$

1. EAS condition : $T_J=25^{\circ}\text{C}, V_{DD}=32V, V_G=10V, L=0.5mH, R_g=25\Omega, I=38A$

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	$R_{\theta JC}$	0.4	$^{\circ}\text{C/W}$
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.0	2.9	3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =50A	-	0.86	1.05	mΩ
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =115A		70	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{ISS}	V _{DS} =20V, V _{GS} =0V, F=1MHz	-	5200	-	PF
Output Capacitance	C _{OSS}		-	3600	-	PF
Reverse Transfer Capacitance	C _{RSS}		-	86	-	PF
Gate resistance	R _g	V _{GS} =0V, f=1MHz	-	2.5		Ω
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}	V _{DD} =20V, I _D =20A V _{GS} =10V, R _G =1.6Ω	-	25	-	nS
Turn-on Rise Time	t _r		-	35	-	nS
Turn-Off Delay Time	t _{d(off)}		-	72	-	nS
Turn-Off Fall Time	t _f		-	26	-	nS
Total Gate Charge	Q _g	V _{DS} =20V, I _D =20A, V _{GS} =10V	-	105	-	nC
Gate-Source Charge	Q _{gs}		-	25		nC
Gate-Drain Charge	Q _{gd}		-	26		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V, I _S =50A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	260	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =20A di/dt = 100A/μs	-	85	-	nS
Reverse Recovery Charge	Q _{rr}		-	52	-	nC



Typical Electrical and Thermal Characteristics

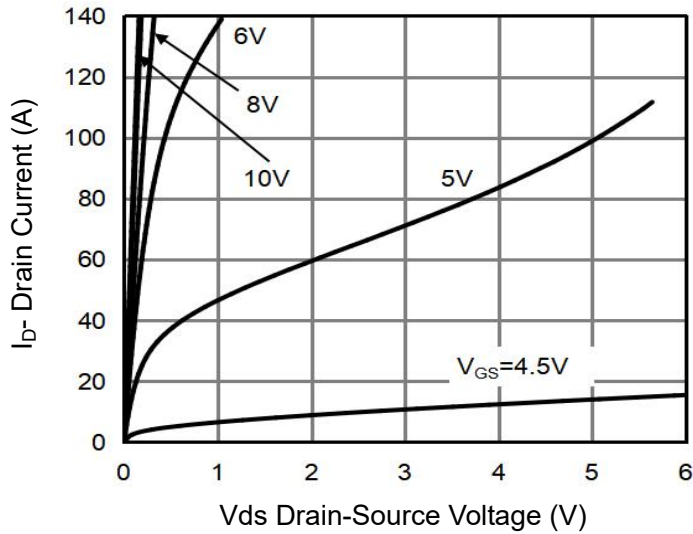


Figure 1 Output Characteristics

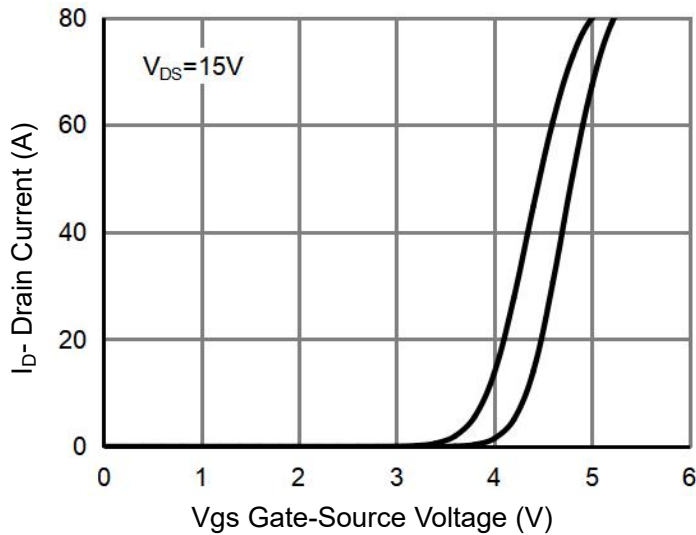


Figure 2 Transfer Characteristics

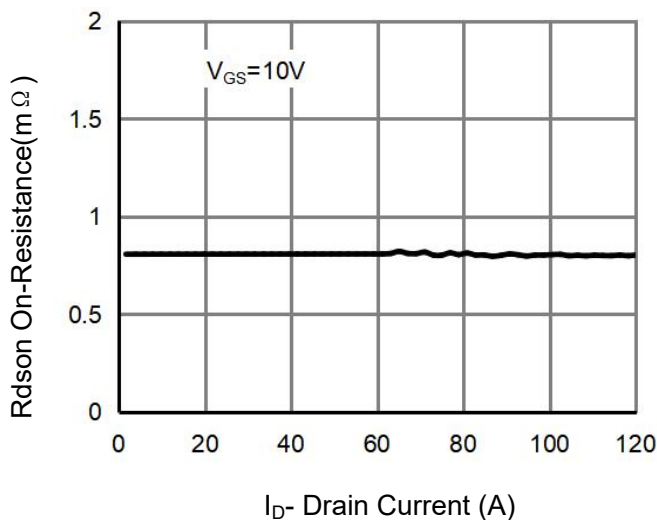


Figure 3 $R_{DS(on)}$ - Drain Current

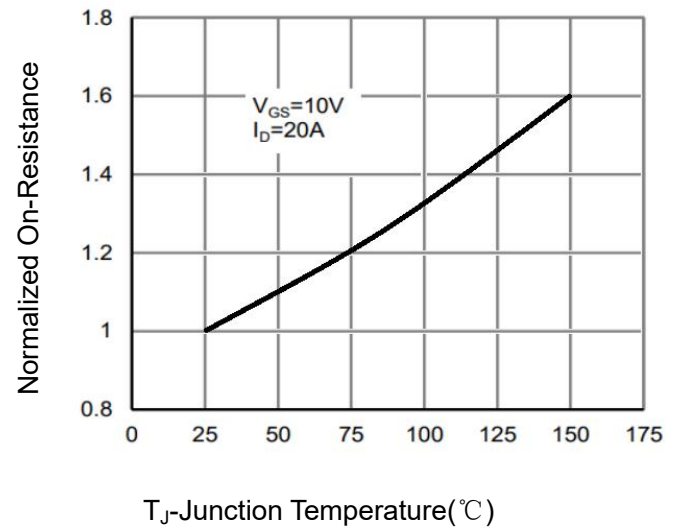


Figure 4 $R_{DS(on)}$ -Junction Temperature

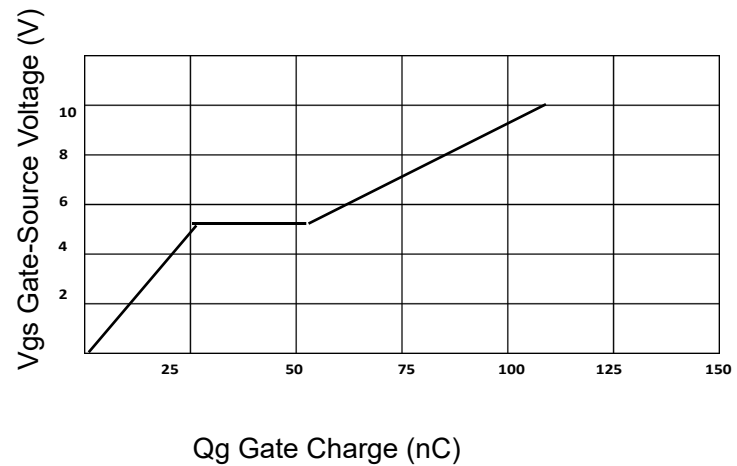


Figure 5 Gate Charge

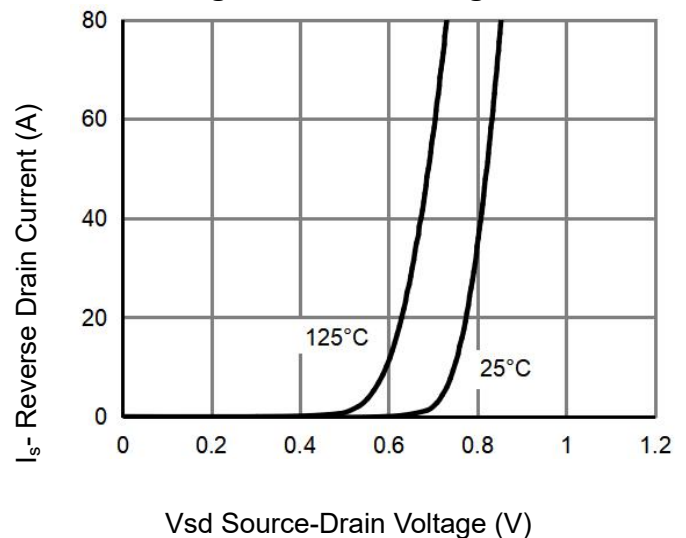
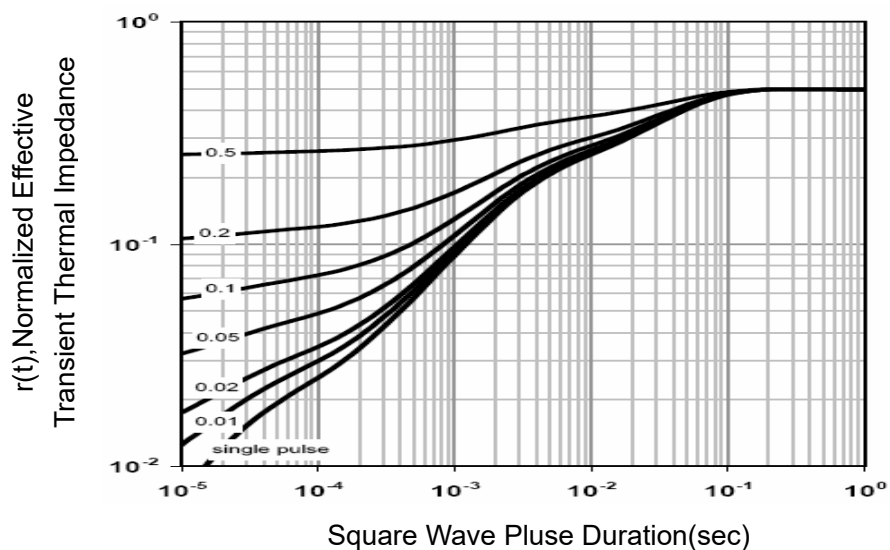
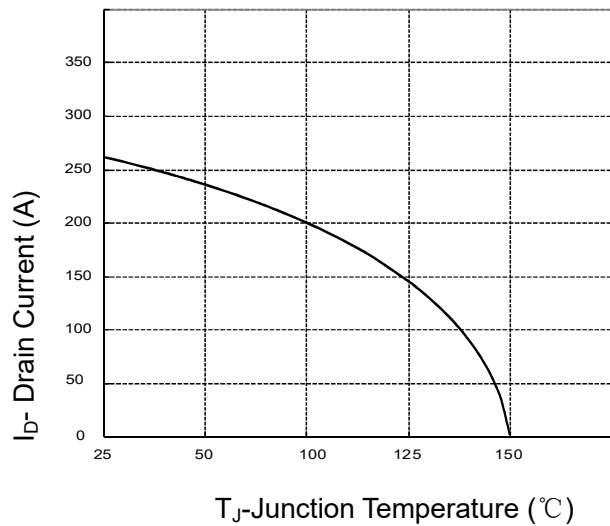
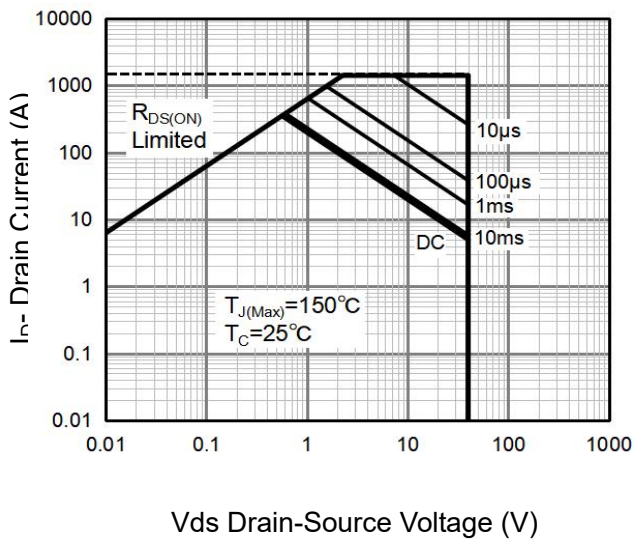
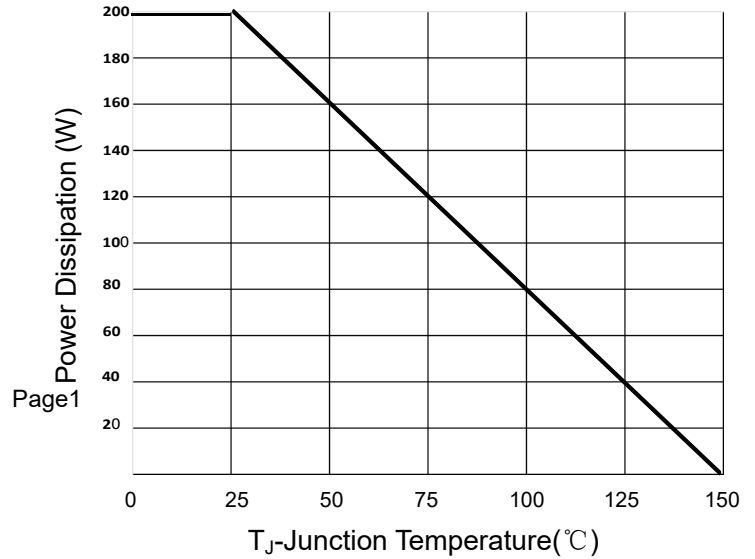
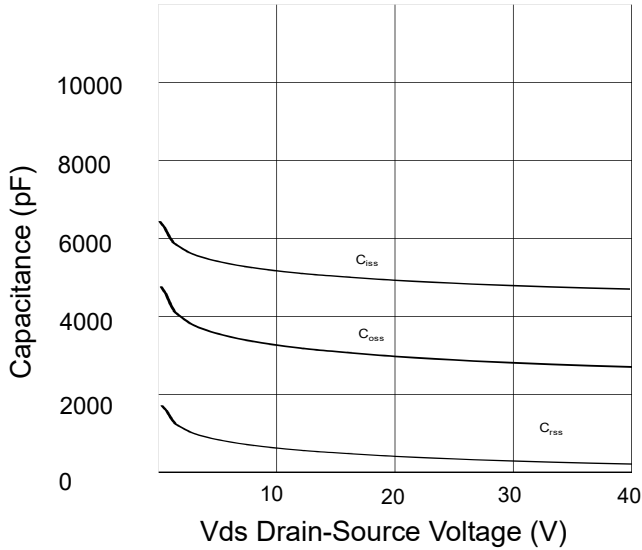
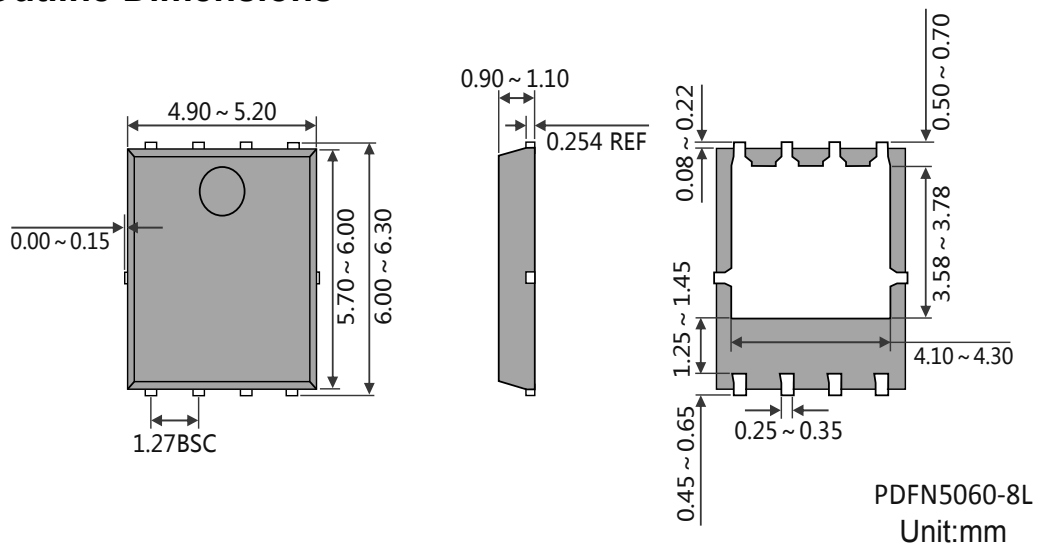


Figure 6 Source- Drain Diode Forward

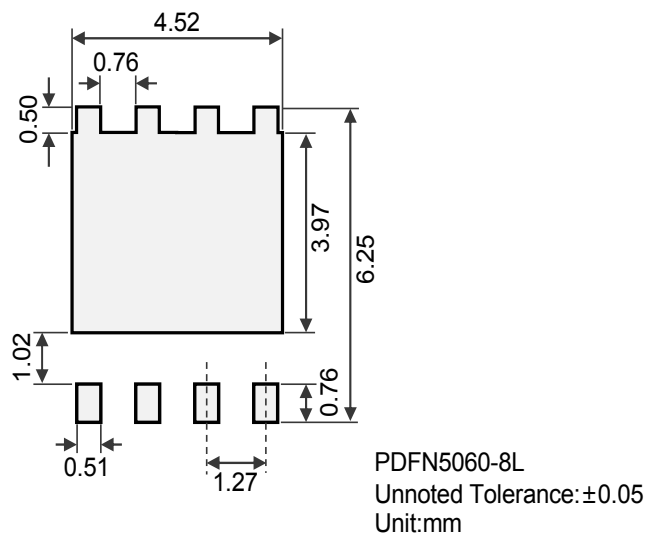




Package Outline Dimensions



Suggested Solder Pad Layout



Marking Information

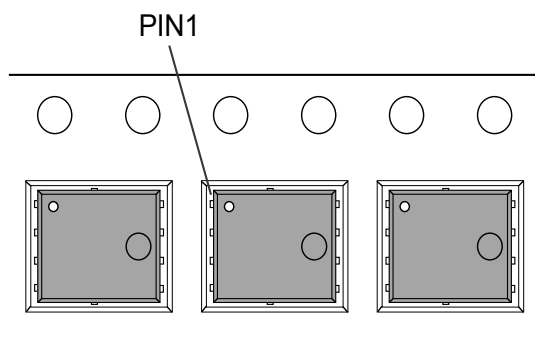


"MHCHXM" = Product Logo
"Marking Code" = The Following
"XXXX" = Date Code Marking

Marking Code	Part Number
S40N11HNA	HXMS40N11HNA



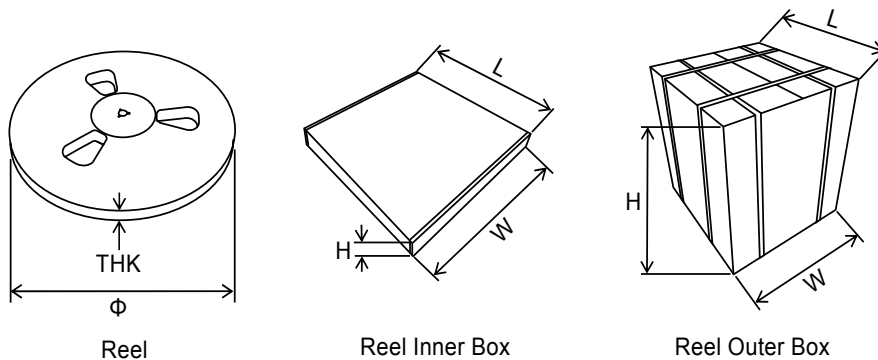
The Orientation Of The Product In The Carrier Tape



Packing Information

Packaging	Part Number	Quantity(pcs)	Size(mm)
Reel	Reel	5000	$\Phi 330 \times \text{THK}15$
	Inner Box	10000	L355×W335×H48
	Outer Box	80000	L415×W375×H360

Packaging:Reel



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